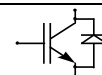


# Technische Information / Technical Information

IGBT-Module  
IGBT-Modules

## BSM15GP60

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### Elektrische Eigenschaften / Electrical properties

#### Höchstzulässige Werte / Maximum rated values

##### Diode Gleichrichter/ Diode Rectifier

|  |  |             |      |                      |
|--|--|-------------|------|----------------------|
| Periodische Rückw. Spitzensperrspannung<br>repetitive peak reverse voltage |  | $V_{RRM}$   | 1600 | V                    |
| Durchlaßstrom Grenzeffektivwert<br>RMS forward current per chip            |  | $I_{FRMSM}$ | 40   | A                    |
| Dauergleichstrom<br>DC forward current                                     | $T_C = 80^\circ\text{C}$                         | $I_d$       | 15   | A                    |
| Stoßstrom Grenzwert<br>surge forward current                               | $t_p = 10\text{ ms}, T_{vj} = 25^\circ\text{C}$  | $I_{FSM}$   | 300  | A                    |
|  | $t_p = 10\text{ ms}, T_{vj} = 150^\circ\text{C}$ |             | 230  | A                    |
| Grenzlastintegral<br>$I^2t$ - value  | $t_p = 10\text{ ms}, T_{vj} = 25^\circ\text{C}$  | $I^2t$      | 450  | $\text{A}^2\text{s}$ |
|  | $t_p = 10\text{ ms}, T_{vj} = 150^\circ\text{C}$ |             | 260  | $\text{A}^2\text{s}$ |

##### Transistor Wechselrichter/ Transistor Inverter

|  |   |              |         |   |
|--|---|--------------|---------|---|
| Kollektor-Emitter-Sperrspannung<br>collector-emitter voltage             |   | $V_{CES}$    | 600     | V |
| Kollektor-Dauergleichstrom<br>DC-collector current                       | $T_C = 80^\circ\text{C}$                    | $I_{C,nom.}$ | 15      | A |
|  | $T_C = 25^\circ\text{C}$                    | $I_C$        | 25      | A |
| Periodischer Kollektor Spitzenstrom<br>repetitive peak collector current | $t_p = 1\text{ ms}, T_C = 80^\circ\text{C}$ | $I_{CRM}$    | 30      | A |
| Gesamt-Verlustleistung<br>total power dissipation                        | $T_C = 25^\circ\text{C}$                    | $P_{tot}$    | 100     | W |
| Gate-Emitter-Spitzenspannung<br>gate-emitter peak voltage                |   | $V_{GES}$    | +/- 20V | V |

##### Diode Wechselrichter/ Diode Inverter

|  |  |           |    |                      |
|--|--|-----------|----|----------------------|
| Dauergleichstrom<br>DC forward current                     | $T_C = 80^\circ\text{C}$   | $I_F$     | 15 | A                    |
| Periodischer Spitzenstrom<br>repetitive peak forw. current | $t_p = 1\text{ ms}$  | $I_{FRM}$ | 30 | A                    |
| Grenzlastintegral<br>$I^2t$ - value                        | $V_R = 0\text{V}, t_p = 10\text{ms}, T_{vj} = 125^\circ\text{C}$ | $I^2t$    | 70 | $\text{A}^2\text{s}$ |

##### Transistor Brems-Chopper/ Transistor Brake-Chopper

|  |   |              |         |   |
|--|---|--------------|---------|---|
| Kollektor-Emitter-Sperrspannung<br>collector-emitter voltage             |   | $V_{CES}$    | 600     | V |
| Kollektor-Dauergleichstrom<br>DC-collector current                       | $T_C = 80^\circ\text{C}$                    | $I_{C,nom.}$ | 10      | A |
|  | $T_C = 25^\circ\text{C}$                    | $I_C$        | 20      | A |
| Periodischer Kollektor Spitzenstrom<br>repetitive peak collector current | $t_p = 1\text{ ms}, T_C = 80^\circ\text{C}$ | $I_{CRM}$    | 20      | A |
| Gesamt-Verlustleistung<br>total power dissipation                        | $T_C = 25^\circ\text{C}$                    | $P_{tot}$    | 80      | W |
| Gate-Emitter-Spitzenspannung<br>gate-emitter peak voltage                |   | $V_{GES}$    | +/- 20V | V |

##### Diode Brems-Chopper/ Diode Brake-Chopper

|  |                          |           |    |   |
|--|--------------------------|-----------|----|---|
| Dauergleichstrom<br>DC forward current                     | $T_C = 80^\circ\text{C}$ | $I_F$     | 10 | A |
| Periodischer Spitzenstrom<br>repetitive peak forw. current | $t_p = 1\text{ ms}$      | $I_{FRM}$ | 20 | A |

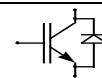
|                             |                                 |
|-----------------------------|---------------------------------|
| prepared by: Andreas Schulz | date of publication: 17.09.1999 |
| approved by: M.Hierholzer   | revision: 3                     |

# Technische Information / Technical Information

IGBT-Module  
IGBT-Modules

## BSM15GP60

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### Modul Isolation/ Module Isolation

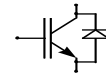
|  |  |            |     |    |
|--|--|------------|-----|----|
| Isolations-Prüfspannung<br>insulation test voltage | RMS, f = 50 Hz, t = 1 min.<br>NTC connected to Baseplate | $V_{ISOL}$ | 2,5 | kV |
|--|--|------------|-----|----|

### Elektrische Eigenschaften / Electrical properties

#### Charakteristische Werte / Characteristic values

| Diode Gleichrichter/ Diode Rectifier   |  | min.          | typ. | max. |         |
|--|--|---------------|------|------|---------|
| Durchlaßspannung<br>forward voltage  | $T_{vj} = 150^{\circ}\text{C}$ , $I_F = 15\text{ A}$   | $V_F$         | -    | 0,95 | 1 V     |
| Schleusenspannung<br>threshold voltage                                       | $T_{vj} = 150^{\circ}\text{C}$                         | $V_{(TO)}$    | -    | -    | 0,8 V   |
| Ersatzwiderstand<br>slope resistance   | $T_{vj} = 150^{\circ}\text{C}$                         | $r_T$         | -    | -    | 10,5 mΩ |
| Sperrstrom<br>reverse current  | $T_{vj} = 150^{\circ}\text{C}$ , $V_R = 1600\text{ V}$ | $I_R$         | -    | 2    | - mA    |
| Modul Leitungswiderstand, Anschlüsse-Chip<br>lead resistance, terminals-chip | $T_C = 25^{\circ}\text{C}$                             | $R_{AA'+CC'}$ | -    | 8    | - mΩ    |

| Transistor Wechselrichter/ Transistor Inverter                               |   | min.                | typ. | max. |        |
|--|---|---------------------|------|------|--------|
| Kollektor-Emitter Sättigungsspannung<br>collector-emitter saturation voltage | $V_{GE} = 15\text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$ , $I_C = 15\text{ A}$  | $V_{CE\text{ sat}}$ | -    | 1,95 | 2,45 V |
|  | $V_{GE} = 15\text{ V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $I_C = 15\text{ A}$   |                     | -    | 2,2  | - V    |
| Gate-Schwellenspannung<br>gate threshold voltage                             | $V_{CE} = V_{GE}$ , $T_{vj} = 25^{\circ}\text{C}$ , $I_C = 0,4\text{ mA}$   | $V_{GE(TO)}$        | 4,5  | 5,5  | 6,5 V  |
| Eingangskapazität<br>input capacitance                                       | $f = 1\text{ MHz}$ , $T_{vj} = 25^{\circ}\text{C}$<br>$V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$  | $C_{ies}$           | -    | 0,8  | - nF   |
| Kollektor-Emitter Reststrom<br>collector-emitter cut-off current             | $V_{GE} = 0\text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$ , $V_{CE} = 600\text{ V}$   | $I_{CES}$           | -    | 0,5  | 500 μA |
|  | $V_{GE} = 0\text{ V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $V_{CE} = 600\text{ V}$  |                     | -    | 0,8  | - mA   |
| Gate-Emitter Reststrom<br>gate-emitter leakage current                       | $V_{CE} = 0\text{ V}$ , $V_{GE} = 20\text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$  | $I_{GES}$           | -    | -    | 300 nA |
| Einschaltverzögerungszeit (ind. Last)<br>turn on delay time (inductive load) | $I_C = I_{Nenn}$ , $V_{CC} = 300\text{ V}$  | $t_{d,on}$          | -    | 50   | - ns   |
|  | $V_{GE} = \pm 15\text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$ , $R_G = 67\text{ Ohm}$  |                     |      |      |        |
|  | $V_{GE} = \pm 15\text{ V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $R_G = 67\text{ Ohm}$   |                     |      |      |        |
| Anstiegszeit (induktive Last)<br>rise time (inductive load)                  | $I_C = I_{Nenn}$ , $V_{CC} = 300\text{ V}$  | $t_r$               | -    | 50   | - ns   |
|  | $V_{GE} = \pm 15\text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$ , $R_G = 67\text{ Ohm}$  |                     |      |      |        |
|  | $V_{GE} = \pm 15\text{ V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $R_G = 67\text{ Ohm}$   |                     |      |      |        |
| Abschaltverzögerungszeit (ind. Last)<br>turn off delay time (inductive load) | $I_C = I_{Nenn}$ , $V_{CC} = 300\text{ V}$  | $t_{d,off}$         | -    | 250  | - ns   |
|  | $V_{GE} = \pm 15\text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$ , $R_G = 67\text{ Ohm}$  |                     |      |      |        |
|  | $V_{GE} = \pm 15\text{ V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $R_G = 67\text{ Ohm}$   |                     |      |      |        |
| Fallzeit (induktive Last)<br>fall time (inductive load)                      | $I_C = I_{Nenn}$ , $V_{CC} = 300\text{ V}$  | $t_f$               | -    | 30   | - ns   |
|  | $V_{GE} = \pm 15\text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$ , $R_G = 67\text{ Ohm}$  |                     |      |      |        |
|  | $V_{GE} = \pm 15\text{ V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $R_G = 67\text{ Ohm}$   |                     |      |      |        |
| Einschaltverlustenergie pro Puls<br>turn-on energy loss per pulse            | $I_C = I_{Nenn}$ , $V_{CC} = 300\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $R_G = 67\text{ Ohm}$<br>$L_S = 75\text{ nH}$                         | $E_{on}$            | -    | 0,7  | - mWs  |
| Abschaltverlustenergie pro Puls<br>turn-off energy loss per pulse            | $I_C = I_{Nenn}$ , $V_{CC} = 300\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $R_G = 67\text{ Ohm}$<br>$L_S = 75\text{ nH}$                         | $E_{off}$           | -    | 0,5  | - mWs  |
| Kurzschlußverhalten<br>SC Data   | $t_p \leq 10\mu\text{s}$ , $V_{GE} \leq 15\text{ V}$ , $R_G = 67\text{ Ohm}$<br>$T_{vj} \leq 125^{\circ}\text{C}$ , $V_{CC} = 360\text{ V}$<br>$dI/dt = 900\text{ A}/\mu\text{s}$ | $I_{SC}$            | -    | 65   | - A    |



**Elektrische Eigenschaften / Electrical properties**

**Charakteristische Werte / Characteristic values**

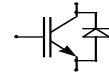
|  |   | min.            | typ. | max.        |      |                      |
|--|---|-----------------|------|-------------|------|----------------------|
| Modulinduktivität<br>stray inductance module                                 |   | $L_{\sigma CE}$ | -    | -           | 100  | nH                   |
| Modul Leitungswiderstand, Anschlüsse-Chip<br>lead resistance, terminals-chip | $T_C = 25^\circ C$  | $R_{CC+EE}$     | -    | 11          | -    | m $\Omega$           |
| <b>Diode Wechselrichter/ Diode Inverter</b>                                  |   | <b>min.</b>     |      | <b>typ.</b> |      | <b>max.</b>          |
| Durchlaßspannung<br>forward voltage  | $V_{GE} = 0V, T_{vj} = 25^\circ C, I_F = 15 A$<br>$V_{GE} = 0V, T_{vj} = 125^\circ C, I_F = 15 A$   | $V_F$           | -    | 1,25        | 1,7  | V                    |
| Rückstromspitze<br>peak reverse recovery current                             | $I_F = I_{Nenn}, - di_F/dt = 550A/\mu s$<br>$V_{GE} = -10V, T_{vj} = 25^\circ C, V_R = 300 V$<br>$V_{GE} = -10V, T_{vj} = 125^\circ C, V_R = 300 V$ | $I_{RM}$        | -    | 16          | -    | A                    |
| Sperrverzögerungsladung<br>recovered charge                                  | $I_F = I_{Nenn}, - di_F/dt = 550A/\mu s$<br>$V_{GE} = -10V, T_{vj} = 25^\circ C, V_R = 300 V$<br>$V_{GE} = -10V, T_{vj} = 125^\circ C, V_R = 300 V$ | $Q_r$           | -    | 1,2         | -    | $\mu As$<br>$\mu As$ |
| Abschaltenergie pro Puls<br>reverse recovery energy                          | $I_F = I_{Nenn}, - di_F/dt = 550A/\mu s$<br>$V_{GE} = -10V, T_{vj} = 25^\circ C, V_R = 300 V$<br>$V_{GE} = -10V, T_{vj} = 125^\circ C, V_R = 300 V$ | $E_{RO}$        | -    | 0,25        | -    | mWs<br>mWs           |
| <b>Transistor Brems-Chopper/ Transistor Brake-Chopper</b>                    |   | <b>min.</b>     |      | <b>typ.</b> |      | <b>max.</b>          |
| Kollektor-Emitter Sättigungsspannung<br>collector-emitter saturation voltage | $V_{GE} = 15V, T_{vj} = 25^\circ C, I_C = 10,0 A$<br>$V_{GE} = 15V, T_{vj} = 125^\circ C, I_C = 10,0 A$   | $V_{CE sat}$    | -    | 1,95        | 2,35 | V                    |
| Gate-Schwellenspannung<br>gate threshold voltage                             | $V_{CE} = V_{GE}, T_{vj} = 25^\circ C, I_C = 0,35mA$  | $V_{GE(TO)}$    | 4,5  | 5,5         | 6,5  | V                    |
| Eingangskapazität<br>input capacitance                                       | $f = 1MHz, T_{vj} = 25^\circ C$<br>$V_{CE} = 25 V, V_{GE} = 0 V$  | $C_{ies}$       | -    | 0,6         | -    | nF                   |
| Kollektor-Emitter Reststrom<br>collector-emitter cut-off current             | $V_{GE} = 0V, T_{vj} = 25^\circ C, V_{CE} = 600 V$<br>$V_{GE} = 0V, T_{vj} = 125^\circ C, V_{CE} = 600 V$   | $I_{CES}$       | -    | 0,5         | 500  | $\mu A$<br>mA        |
| Gate-Emitter Reststrom<br>gate-emitter leakage current                       | $V_{CE} = 0V, V_{GE} = 20V, T_{vj} = 25^\circ C$  | $I_{GES}$       | -    | -           | 300  | nA                   |
| <b>Diode Brems-Chopper/ Diode Brake-Chopper</b>                              |   | <b>min.</b>     |      | <b>typ.</b> |      | <b>max.</b>          |
| Durchlaßspannung<br>forward voltage  | $T_{vj} = 25^\circ C, I_F = 10,0 A$<br>$T_{vj} = 125^\circ C, I_F = 10,0 A$   | $V_F$           | -    | 1,25        | 1,75 | V                    |
| <b>NTC-Widerstand/ NTC-Thermistor</b>  |   | <b>min.</b>     |      | <b>typ.</b> |      | <b>max.</b>          |
| Nennwiderstand<br>rated resistance   | $T_C = 25^\circ C$  | $R_{25}$        | -    | 5           | -    | k $\Omega$           |
| Abweichung von $R_{100}$<br>deviation of $R_{100}$                           | $T_C = 100^\circ C, R_{100} = 493 \Omega$   | $\Delta R/R$    | -5   |             | 5    | %                    |
| Verlustleistung<br>power dissipation   | $T_C = 25^\circ C$  | $P_{25}$        |      |             | 20   | mW                   |
| B-Wert<br>B-value  | $R_2 = R_1 \exp [B(1/T_2 - 1/T_1)]$   | $B_{25/50}$     |      | 3375        |      | K                    |

# Technische Information / Technical Information

IGBT-Module  
IGBT-Modules

## BSM15GP60

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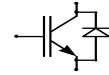


### Thermische Eigenschaften / Thermal properties

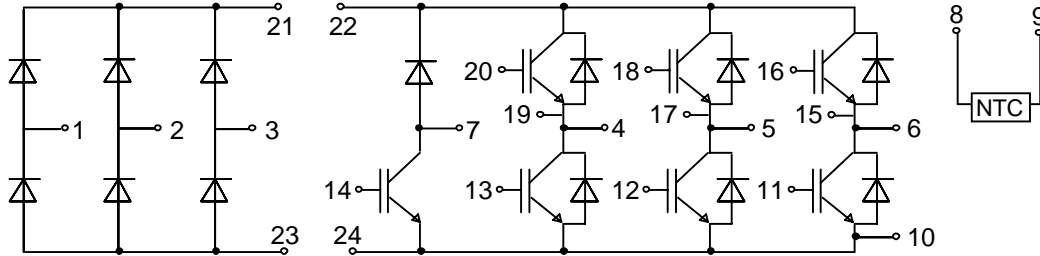
|  |                                | min.                       | typ. | max. |     |     |
|--|--------------------------------|----------------------------|------|------|-----|-----|
| Innerer Wärmewiderstand<br>thermal resistance, junction to case        | Gleicher. Diode/ Rectif. Diode | $R_{thJC}$                 | -    | -    | 1   | K/W |
|  | Trans. Wechr./ Trans. Inverter |                            | -    | -    | 1,3 | K/W |
|  | Diode Wechr./ Diode Inverter   |                            | -    | -    | 1,8 | K/W |
|  | Trans. Bremse/ Trans. Brake    |                            | -    | -    | 1,5 | K/W |
|  | Diode Bremse/ Diode Brake      |                            | -    | -    | 2,3 | K/W |
| Übergangs-Wärmewiderstand<br>thermal resistance, case to heatsink      | Gleicher. Diode/ Rectif. Diode | $R_{thCK}$                 | -    | 0,08 | -   | K/W |
|  | Trans. Wechr./ Trans. Inverter | $\lambda_{paste}=1W/m^2K$  | -    | 0,04 | -   | K/W |
|  | Diode Wechr./ Diode Inverter   | $\lambda_{grease}=1W/m^2K$ | -    | 0,08 | -   | K/W |
| Höchstzulässige Sperrschichttemperatur<br>maximum junction temperature |                                | $T_{vj}$                   | -    | -    | 150 | °C  |
| Betriebstemperatur<br>operation temperature                            |                                | $T_{op}$                   | -40  | -    | 125 | °C  |
| Lagertemperatur<br>storage temperature                                 |                                | $T_{stg}$                  | -40  | -    | 125 | °C  |

### Mechanische Eigenschaften / Mechanical properties

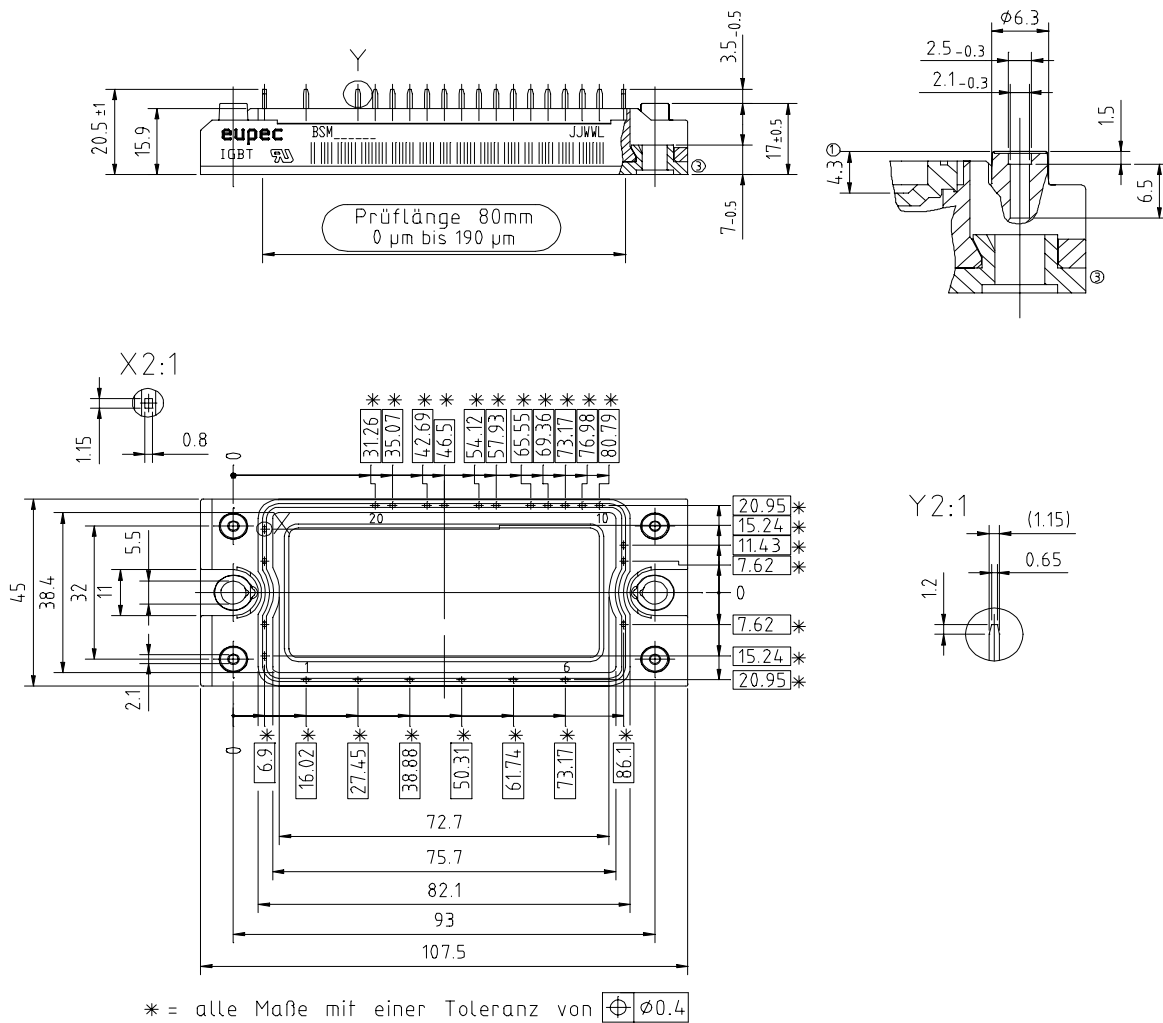
|  |  |   |  |                 |    |
|--|--|---|--|-----------------|----|
| Innere Isolation<br>internal insulation                  |  |   |  | $Al_2O_3$       |    |
| CTI<br>comperative tracking index                        |  |   |  | 225             |    |
| Anzugsdrehmoment f. mech. Befestigung<br>mounting torque |  | M |  | 3<br>$\pm 10\%$ | Nm |
| Gewicht<br>weight  |  | G |  | 180             | g  |



Schaltplan/ Circuit diagram



Gehäuseabmessungen/ Package outlines



Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert. Sie gilt in Verbindung mit den zugehörigen Technischen Erläuterungen.

This technical information specifies semiconductor devices but promises no characteristics. It is valid in combination with the belonging technical notes.